

10V Drive Nch MOSFET

R8008ANX

● Structure

Silicon N-channel MOSFET

● Features

- 1) Low on-resistance.
- 2) Low input capacitance.
- 3) High ESD.

● Application

Switching

● Packaging specifications

Type	Package	Bulk
	Code	-
	Basic ordering unit (pieces)	500
R8008ANX		○

● Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V_{DSS}	800	V
Gate-source voltage		V_{GSS}	±30	V
Drain current	Continuous	I_D^{*3}	±8	A
	Pulsed	I_{DP}^{*1}	±32	A
Source current (Body Diode)	Continuous	I_S^{*3}	8	A
	Pulsed	I_{SP}^{*1}	32	A
Avalanche current		I_{AS}^{*2}	4	A
Avalanche energy		E_{AS}^{*2}	4.2	mJ
Power dissipation		P_D^{*4}	50	W
Channel temperature		T_{ch}	150	°C
Range of storage temperature		T_{stg}	-55 to +150	°C

*1 $P_w \leq 10\mu s$, Duty cycle $\leq 1\%$

*2 $L = 500\mu H$, $V_{DD} = 50V$, $R_G = 25\Omega$, $T_{ch} = 25^\circ C$

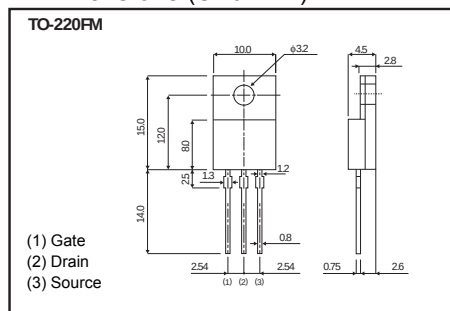
*3 Limited only by maximum channel temperature allowed.

*4 $T_C = 25^\circ C$

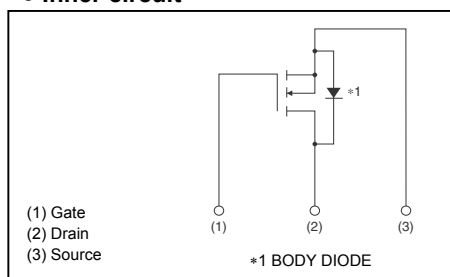
● Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to Case	$R_{th(ch-c)}$	2.5	°C / W

● Dimensions (Unit : mm)



● Inner circuit



● Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	-	-	± 100	nA	$V_{GS} = \pm 30V$, $V_{DS} = 0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	800	-	-	V	$I_D = 1mA$, $V_{GS} = 0V$
Zero gate voltage drain current	I_{DSS}	-	-	100	μA	$V_{DS} = 800V$, $V_{GS} = 0V$
Gate threshold voltage	$V_{GS(th)}$	3.0	-	5.0	V	$V_{DS} = 10V$, $I_D = 1mA$
Static drain-source on-state resistance	$R_{DS(on)}^*$	-	0.79	1.03	Ω	$I_D = 4.0A$, $V_{GS} = 10V$
Forward transfer admittance	$ Y_{fs} ^*$	2.0	-	-	S	$V_{DS} = 10V$, $I_D = 4.0A$
Input capacitance	C_{iss}	-	1080	-	pF	$V_{DS} = 25V$
Output capacitance	C_{oss}	-	480	-	pF	$V_{GS} = 0V$
Reverse transfer capacitance	C_{rss}	-	32	-	pF	$f = 1MHz$
Turn-on delay time	$t_{d(on)}^*$	-	32	-	ns	$V_{DD} = 400V$, $I_D = 4.0A$
Rise time	t_r^*	-	50	-	ns	$V_{GS} = 10V$
Turn-off delay time	$t_{d(off)}^*$	-	85	-	ns	$R_L = 100\Omega$
Fall time	t_f^*	-	30	-	ns	$R_G = 10\Omega$
Total gate charge	Q_g^*	-	39	-	nC	$V_{DD} = 400V$
Gate-source charge	Q_{gs}^*	-	8.7	-	nC	$I_D = 8.0A$
Gate-drain charge	Q_{gd}^*	-	23	-	nC	$V_{GS} = 10V$

*Pulsed

● Body diode characteristics (Source-Drain)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	V_{SD}^*	-	-	1.5	V	$I_S = 8.0A$, $V_{GS} = 0V$

*Pulsed

●Electrical characteristic curves (Ta=25°C)

Fig.1 Typical Output Characteristics (I)

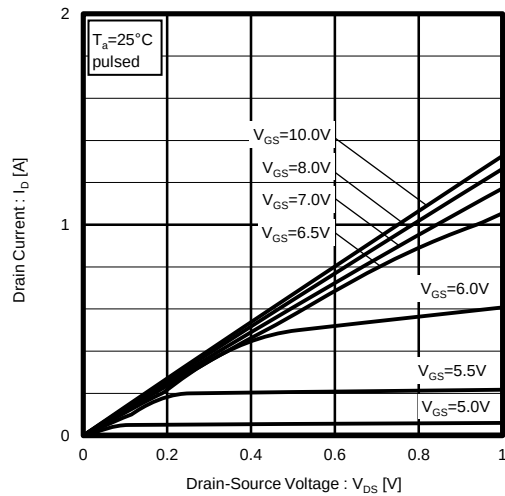


Fig.2 Typical Output Characteristics (II)

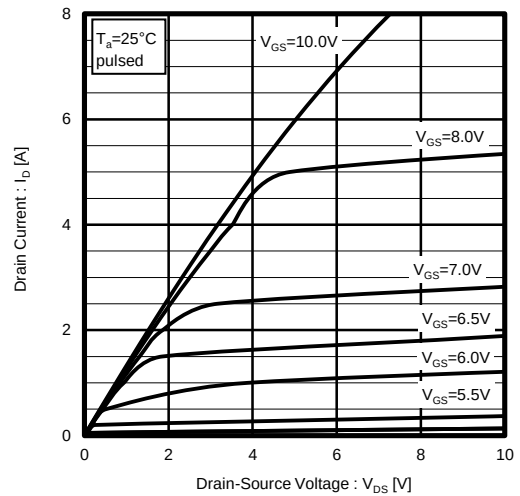


Fig.3 Typical Transfer Characteristics

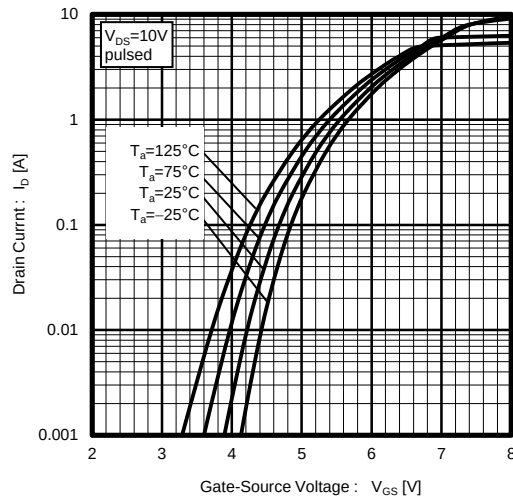


Fig.4 Gate Threshold Voltage vs. Channel Temperature

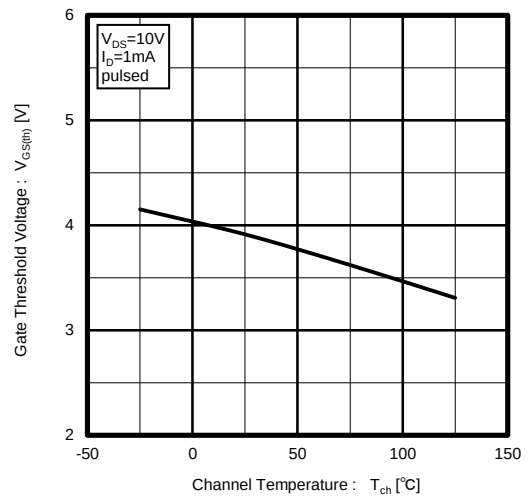


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

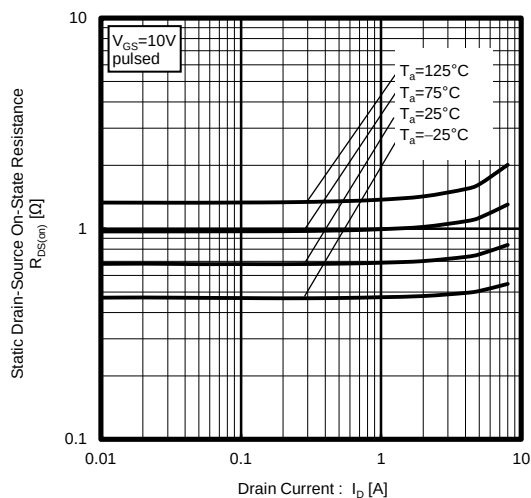


Fig.6 Static Drain-Source On-State Resistance vs. Channel Temperature

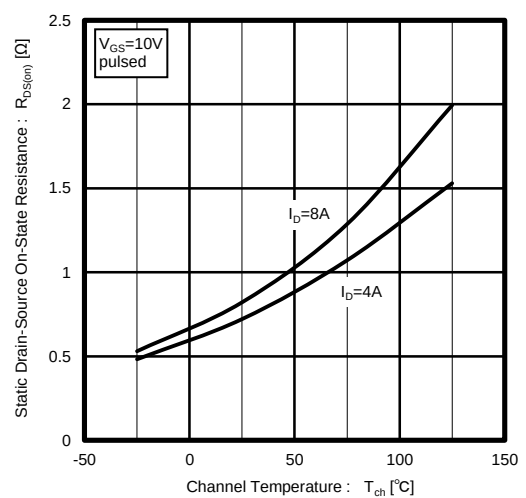


Fig.7 Forward Transfer Admittance vs. Drain Current

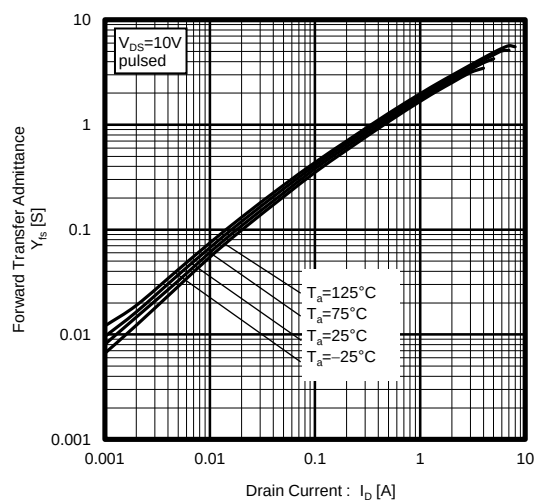


Fig.8 Source Current vs. Source-Drain Voltage

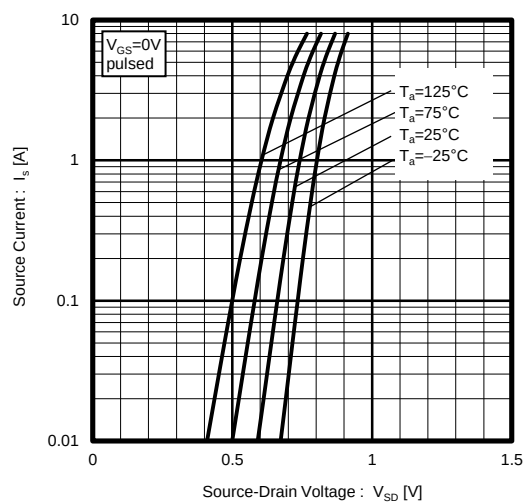
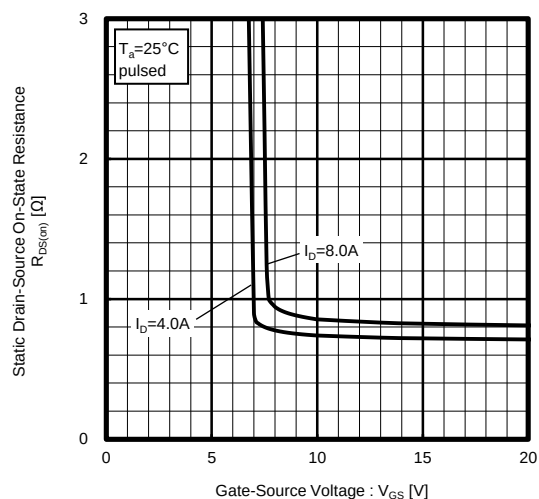


Fig.9 Static Drain-Source On-State Resistance vs. Gate-Source Voltage



● Measurement circuits

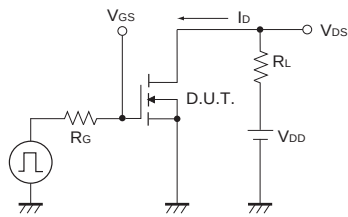


Fig.1-1 Switching Time Measurement Circuit

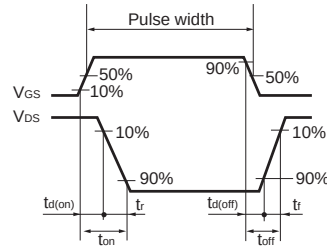


Fig.1-2 Switching Waveforms

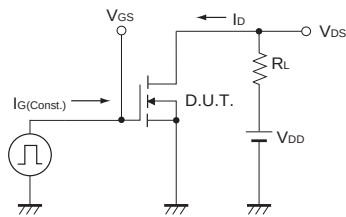


Fig.2-1 Gate Charge Measurement Circuit

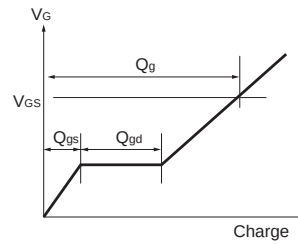


Fig.2-2 Gate Charge Waveform

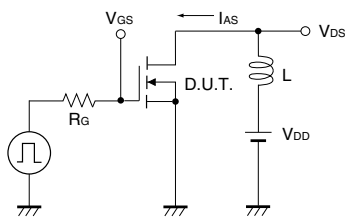


Fig.3-1 Avalanche Measurement Circuit

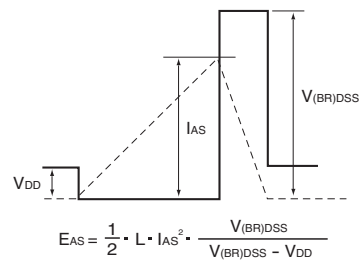


Fig.3-2 Avalanche Waveform

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